

Selection Guide

			7C291A-20	7C291A-25	7C291A-35 7C291AL-35	7C291A-50	Unit
Maximum Acces	ss Time		20	25	35	50	ns
Maximum	Standard	Commercial	120	90	90	90	mA
Operating Current		Military			90		mA
	L	Commercial			60		mA

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature-65°C to+150°C Ambient Temperature with Power Applied......55°C to+125°C Supply Voltage to Ground Potential-0.5V to+7.0V DC Voltage Applied to Outputs in High Z State-0.5V to+7.0V DC Input Voltage-3.0V to +7.0V

DC Program Voltage	13.0V
UV Exposure	7258 Wsec/cm ²
Static Discharge Voltage(per MIL-STD-883, Method 3015)	>2001V
Latch-Up Current	>200 mA

Operating Range

Range	Ambient Temperature	V _{cc}
Commercial	0°C to + 70°C	5V ±10%
Military ^[1]	–55°C to + 125°C	5V ±10%

 $[\]label{eq:Note} \mbox{1.} \quad \mbox{T}_{\mbox{A}} \mbox{ is the "instant on" case temperature.}$



Electrical Characteristics Over the Operating Range^[2,3]

				7C29	7C291A-20		7C291A-25	
Parameter	Description	Test Cond	litions	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min., I_{OH} =$	-4.0 mA	2.4		2.4		V
V _{OL}	Output LOW Voltage	$V_{CC} = Min., I_{OL} =$	16.0 mA		0.4		0.4	V
V _{IH}	Input HIGH Voltage	Guaranteed Inp HIGH Voltage fo		2.0	V _{CC}	2.0	V _{CC}	V
V _{IL}	Input LOW Voltage	Guaranteed Inp LOW Voltage fo			0.8		0.8	V
I _{IX}	Input Load Current	$GND \le V_{IN} \le V_{CO}$	<u> </u>	-10	+10	-10	+10	μΑ
V_{CD}	Input Diode Clamp Voltage				•	Note 3	•	•
I _{OZ}	Output Leakage Current	$\begin{aligned} & \text{GND} \leq \text{V}_{\text{OUT}} \leq \text{V}_{\text{CC}}, \\ & \text{Output Disabled} \end{aligned}$		-10	+10	-10	+10	μА
I _{OS}	Output Short Circuit Current ^[4]	$V_{CC} = Max., V_{OU}$	_T = GND	-20	-90	-20	-90	mA
I _{CC}	V _{CC} Operating Supply Current	$V_{CC} = Max.,$ $I_{OUT} = 0 \text{ mA}$	Com'l		120		90	mA
I _{SB}	Standby Supply Current (7C293A Only)	$\frac{V_{CC}}{CS_1} = Max.,$ $\frac{V_{CC}}{CS_1} = V_{IH}$	Com'l		40		30	mA
V _{PP}	Programming Supply Voltage		U.	12	13	12	13	V
I _{PP}	Programming Supply Current				50		50	mA
V _{IHP}	Input HIGH Programming Voltage			3.0		3.0		V
V _{ILP}	Input LOW Programming Voltage				0.4		0.4	V

- Notes
 See the last page of this specification for Group A subgroup testing information.
 See the "Introduction to CMOS PROMs" section of the Cypress Data Book for general information on testing.
 For test purposes, not more than one output at a time should be shorted. Short circuit test duration should not exceed 30 seconds.

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$\textbf{Electrical Characteristics} \ \, \text{Over the Operating Range}^{[2,3]} \, (\text{continued})$

				7C29	1AL-35		1A-35 1A-50	
Parameter	Description	Test Co	nditions	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = Min., I _{OI}	$_{H} = -4.0 \text{ mA}$	2.4		2.4		V
V _{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL}	= 16.0 mA		0.4		0.4	V
V _{IH}	Input HIGH Voltage	Guaranteed II HIGH Voltage		2.0		2.0		V
V _{IL}	Input LOW Voltage	Guaranteed II LOW Voltage			0.8		0.8	V
I _{IX}	Input Load Current	$GND \leq V_{IN} \leq V_{IN}$	/cc	-10	+10	-10	+10	μА
V_{CD}	Input Diode Clamp Voltage				Not	e 3		
I _{OZ}	Output Leakage Current	$\begin{aligned} & \text{GND} \leq \text{V}_{\text{OUT}} \leq \text{V}_{\text{CC}}, \\ & \text{Output Disabled} \end{aligned}$		-10	+10	-10	+10	μА
I _{OS}	Output Short Circuit Current ^[4]	$V_{CC} = Max., V_{CC}$	_{DUT} = GND	-20	-90	-20	-90	mA
I _{CC}	V _{CC} Operating Supply Current	$V_{CC} = Max.,$	Commercial		60		90	mA
		$V_{IN} = 2.0V$ $I_{OUT} = 0 \text{ mA}$	Military				90	
I _{SB}	Standby Supply Current	$\frac{V_{CC}}{CS_1} = Max.,$	Commercial		30		30	mA
	(7C293A Only)	$CS_1 = V_{IH}$	Military				40	
V _{PP}	Programming Supply Voltage			12	13	12	13	V
I _{PP}	Programming Supply Current				50		50	mA
V _{IHP}	Input HIGH Programming Voltage			3.0		3.0		V
V _{ILP}	Input LOW Programming Voltage				0.4		0.4	V

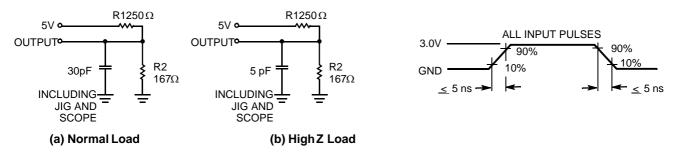
Capacitance^[3]

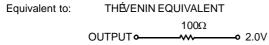
Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	10	pF
C _{OUT}	Output Capacitance	V _{CC} = 5.0V	10	pF

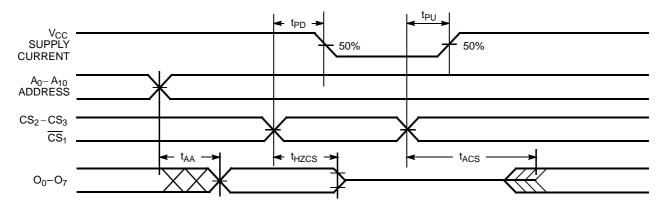
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AC Test Loads and Waveforms[3]







Switching Characteristics Over the Operating Range^[2, 3]

		7C29	1A-20	7C29	1A-25		1A-35 AL-35	7C29	1A-50	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
t _{AA}	Address to Output Valid		20		25		35		50	ns
t _{HZCS1}	Chip Select Inactive to High Z		15		15		20		20	ns
t _{ACS1}	Chip Select Active to Output Valid		15		15		20		20	ns
t _{HZCS2}	Chip Select Inactive to High Z		22		27		35		45	ns
t _{ACS2}	Chip Select Active to Output Valid		22		27		35		45	ns
t _{PU}	Chip Select Active to Power-Up	0		0		0		0		ns
t _{PD}	Chip Select Inactive to Power-Down		22		27		35		45	ns



Erasure Characteristics

Wavelengths of light less than 4000 Angstroms begin to erase these PROMs. For this reason, an opaque label should be placed over the window if the PROM is exposed to sunlight or fluorescent lighting for extended periods of time.

The recommended dose of ultraviolet light for erasure is a wavelength of 2537 Angstroms for a minimum dose (UV intensity x exposure time) of 25 Wsec/cm2. For an ultraviolet lamp with a 12 mW/cm² power rating, the exposure time would be approximately 35 minutes.

These PROMs need to be within 1 inch of the lamp during erasure. Permanent damage may result if the PROM is exposed to high-intensity UV light for an extended period of time. 7258 Wsec/cm² is the recommended maximum dosage.

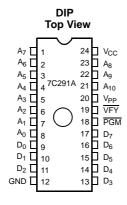
Programming Information

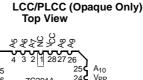
Programming support is available from Cypress as well as from a number of third-party software vendors. For detailed programming information, including a listing of software packages, please see the PROM Programming Information located at the end of this section. Programming algorithms can be obtained from any Cypress representative.

Table 1. Mode Selection

				Pin Function ^[5]		
	Read or Output Disable	A ₁₀ -A ₀	CS ₃	CS ₂	CS ₁	O ₇ -O ₀
Mode	Other	A ₁₀ -A ₀	PGM	VFY	V _{PP}	D ₇ -D ₀
Read		A ₁₀ -A ₀	V _{IH}	V _{IH}	V _{IL}	O ₇ -O ₀
Output Disa	able ^[6]	A ₁₀ -A ₀	Х	Х	V _{IH}	High Z
Output Disa	able	A ₁₀ -A ₀	Х	V _{IL}	Х	High Z
Output Disa	able	A ₁₀ -A ₀	V _{IL}	Х	Х	High Z
Program		A ₁₀ -A ₀	V _{ILP}	V _{IHP}	V _{PP}	D ₇ –D ₀
Program Ve	erify	A ₁₀ -A ₀	V_{IHP}	$V_{\rm ILP}$	V _{PP}	O ₇ -O ₀
Program In	hibit	A ₁₀ -A ₀	V_{IHP}	V_{IHP}	V _{PP}	High Z
Intelligent F	Program	A ₁₀ -A ₀	V _{ILP}	V _{IHP}	V _{PP}	D ₇ D ₀
Blank Chec	ck Zeros	A ₁₀ -A ₀	V_{IHP}	$V_{\rm ILP}$	V _{PP}	Zeros

Figure 1. Programming Pinouts





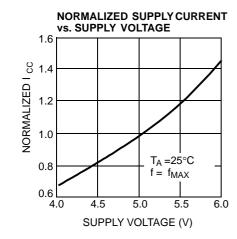
2 2 5 5 2 4 6

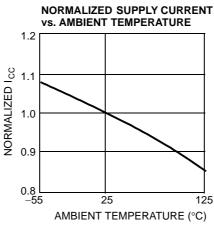
Notes

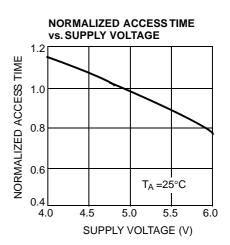
- 5. X = "don't care" but not to exceed $V_{CC} +5\%$.
- 6. The power-down mode for the CY7C293A is activated by deselecting CS₁.

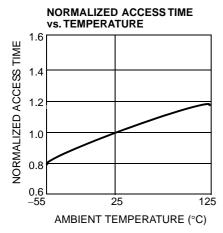


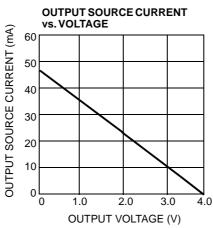
Typical DC and AC Characteristics

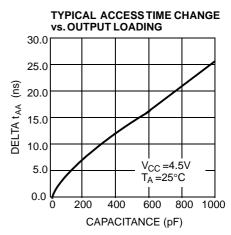


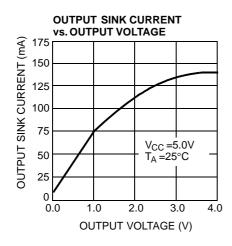


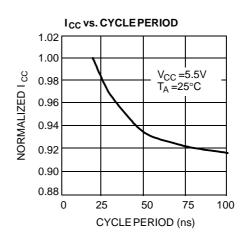














Ordering Information

Speed (ns)	I _{CC} (mA)	Ordering Code	Package Name	Package Type	Operating Range
20	120	CY7C291A-20PC	P13	24-Lead (300-Mil) Molded DIP	Commercial
25	90	CY7C291A-25JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
		CY7C291A-25PC	P13	24-Lead (300-Mil) Molded DIP	
35	60	CY7C291AL-35JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
		CY7C291AL-35PC	P13	24-Lead (300-Mil) Molded DIP	
		CY7C291AL-35WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	90	CY7C291A-35JC	J64	28-Lead Plastic Leaded Chip Carrier	Commercial
		CY7C291A-35PC	P13	24-Lead (300-Mil) Molded DIP	
		CY7C291A-35WC	W14	24-Lead (300-Mil) Windowed CerDIP	
	120	CY7C291A-35DMB	D14	24-Lead (300-Mil) CerDIP	Military
50	90	CY7C291A-50PC	P13	24-Lead (300-Mil) Molded DIP	Commercial
		CY7C291A-50WMB	W14	24-Lead (300-Mil) Windowed CerDIP	Military

MILITARY SPECIFICATIONS Group A Subgroup Testing

DC Characteristics

Parameter	Subgroups
V _{OH}	1, 2, 3
V _{OL}	1, 2, 3
V _{IH}	1, 2, 3
V _{IL}	1, 2, 3
I _{IX}	1, 2, 3
l _{OZ}	1, 2, 3
I _{CC}	1, 2, 3
I _{SB}	1, 2, 3

SMD Cross Reference

SMD Number	Suffix	Cypress Number
5962-87650	01LX	CY7C291-50WMB
5962-87650	03LX	CY7C291-35WMB
5962-88734	023X	CY7C291A-35LMB
5962-88734	033X	CY7C291A-35LMB
5962-88734	04LX	CY7C291A-25DMB
5962-88734	043X	CY7C291A-25LMB

Switching Characteristics

Parameter	Subgroups
t _{AA}	7, 8, 9, 10, 11
t _{ACS1}	7, 8, 9, 10, 11

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Package Diagrams

Figure 2. 24-Lead (300-Mil) CerDIP D14

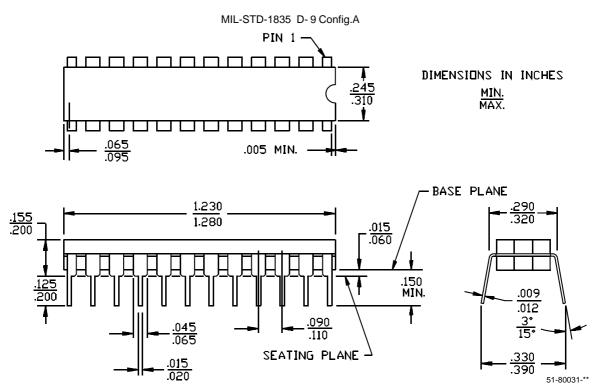
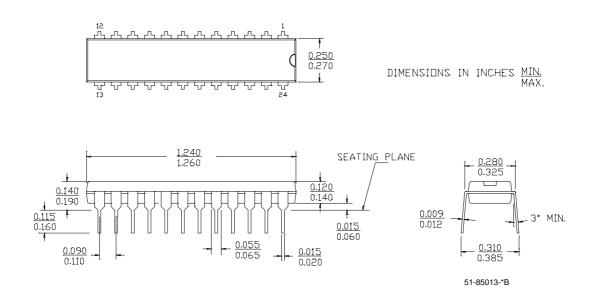


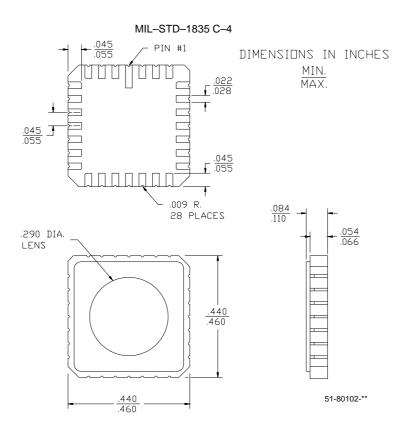
Figure 3. 24-Lead (300-Mil) PDIP P13





Package Diagrams (continued)

Figure 4. 28-Pin Windowed Leadless Chip Carrier Q64

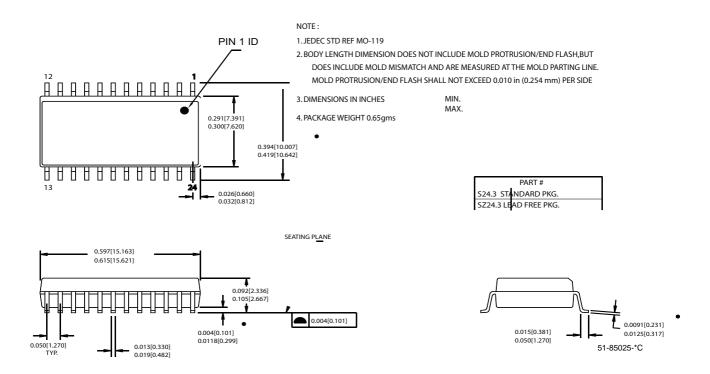


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Package Diagrams (continued)

Figure 5. 24 Lead (300 Mil) SOIC - S13





Package Diagrams (continued)

Figure 6. 24-Lead (300-Mil) Windowed CerDIP W14

MIL-STD-1835 D-9 Config. A .175 DIA. PIN 1 LENS DIMENSIONS IN INCHES MIN. .005 MIN. BASE PLANE 1.230 290 1.280 .015 .060 .150 MIN. .012 3° .090 .110 SEATING PLANE 330 390 51-80086-**

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Document History Page

Document Title: CY7C291A 2K x 8 Reprogrammable PROM Document Number: 38-04011				
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	114138	03/18/02	DSG	Changed from Spec number: 38-00075 to 38-04011
*A	118905	10/11/02	GBI	Updated ordering information
*B	499562	See ECN	PCI	Updated ordering information

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